

Wiring, Printed - Flexible Material Constructions - Component

COMPANY

BASELECTRON SRL

Via Mons. Angelini 18

San Martino Siccomario, PV 27028 Italy

E477015

Cond Width		Max		Report		Max									
Min		Cond	SS/	Area	Date	Surface	Assembly Solder		Solder	Oper	Meets		C		
Min	Edge	Thk	DS/	Diam	After	Mount	Process	Process	Limits	Temp	Flame	UL796F	T		
Type	mm	mm	mic	DSO	mm	2022-01-01	Technology	Temp °C	Cycles	°C	sec	°C	Class	DSR	I
Multilayer flexible materials interconnect constructions (Flexible Application)															
FM	0.09	0.09	12 Int:35	DS	50.8	No	-	-	-	288	20	105	V-0	-	-
Multilayer Rigid Flex Composite, Flexible Materials Interconnect Constructions (Flexible Application)															
RF	0.09	0.09	35 Int:35	DS	50.8	No	-	-	-	288	10	120	V-0	-	-
Single layer flexible materials interconnect constructions(Flexible Application)															
F	0.09	0.09	12	DS	50.8	No	-	-	-	288	20	105	V-0	-	-

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